

## RX Family

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### USB Peripheral Human Interface Devices Class Driver for USB Mini Firmware Using Firmware Integration Technology

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#### Introduction

This application note describes USB Peripheral Human Interface Devices Class Driver (PHID), which utilizes Firmware Integration Technology (FIT). This module operates in combination with the USB Basic Mini Host and Peripheral Driver. It is referred to below as the USB PHID FIT module.

#### Target Device

RX111 Group  
RX113 Group  
RX231 Group  
RX23W Group

When using this application note with other Renesas MCUs, careful evaluation is recommended after making modifications to comply with the alternate MCU.

#### Related Documents

1. Universal Serial Bus Revision 2.0 specification
2. RX111 Group User's Manual: Hardware (Document number .R01UH0365)
3. RX113 Group User's Manual: Hardware (Document number.R01UH0448)
4. RX231 Group User's Manual: Hardware (Document number .R01UH0496)
5. RX23W Group User's Manual: Hardware (Document number .R01UH0823)
6. USB Basic Mini Host and Peripheral Driver (USB Mini Firmware) using Firmware Integration Technology Application Note (Document number.R01AN2166)

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## 1. Overview

The USB PHID FIT module, when used in combination with the USB-BASIC-F/W FIT module, operates as a USB peripheral human interface device class driver (PHID). The PHID conforms to the USB Human Interface Device class specifications (referred to here as HID) and implements communication with a HID host.

This module supports the following functions.

- Data transfer to and from a USB host
- Response to HID class requests
- Response to function references from the HID host
- Interrupt OUT transfer

### 1.1 Please be sure to read

Please refer to the document (Document number: R01AN2166) for *USB Basic Mini Host and Peripheral Driver (USB Mini Firmware) using Firmware Integration Technology Application Note* when creating an application program using this driver.

This document is located in the "**reference\_documents**" folder within this package.

### 1.2 Note

This driver is not guaranteed to provide USB communication operation. The customer should verify operation when utilizing it in a system and confirm the ability to connect to a variety of different types of devices.

### 1.3 Terms and Abbreviations

Terms and abbreviations used in this document are listed below.

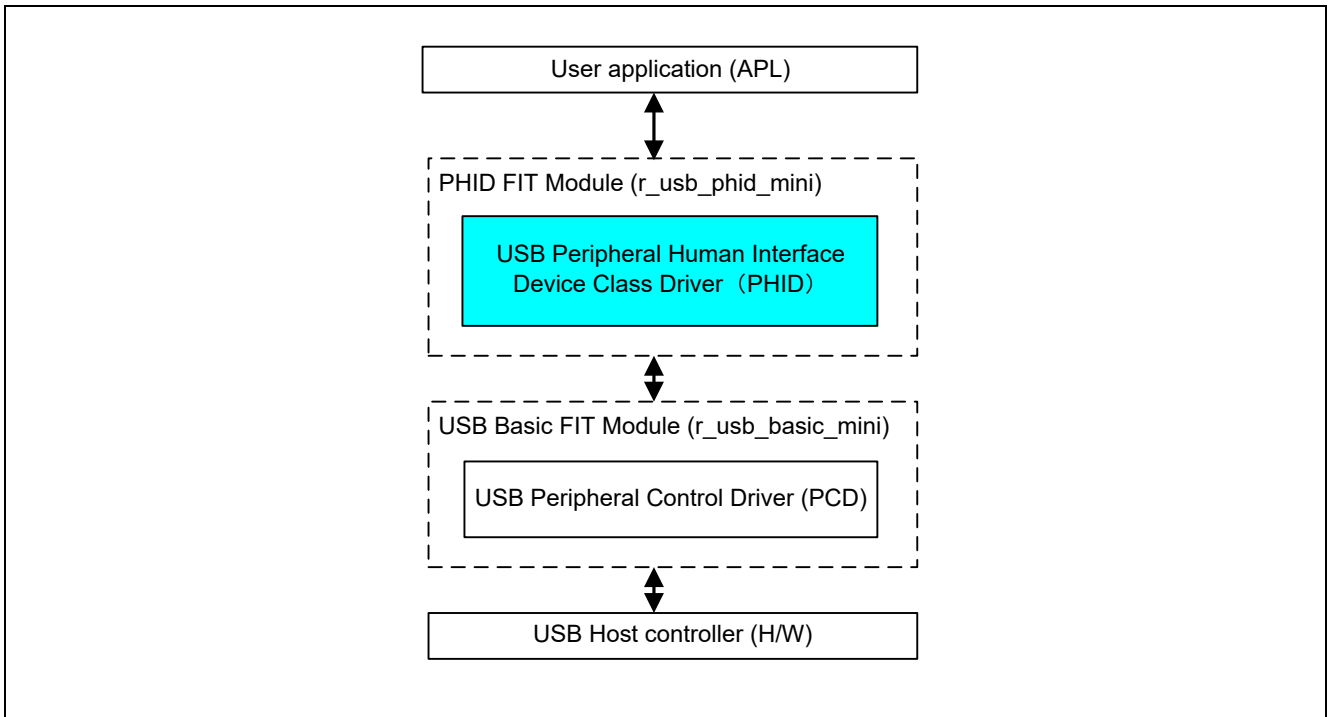
API	:	Application Program Interface
APL	:	Application program
HID	:	Human Interface Device class
IDE	:	Integrated Development Environment
PCD	:	Peripheral control driver of USB-BASIC-F/W
PDCD	:	Peripheral device class driver (device driver and USB class driver)
PHID	:	Peripheral Human Interface Devices
RTOS	:	USB Driver for the real-time OS
USB	:	Universal Serial Bus
USB-BASIC-FW	:	USB Basic Mini Host and Peripheral Driver

### 1.4 USB PHID FIT Module

User needs to integrate this module to the project using `r_usb_basic_mini`. User can control USB H/W by using this module API after integrating to the project.

## 2. Software Configuration

Figure 2-1 shows the configuration of the modules related to PHID



**Figure 2-1 Software Module Structure**

**Table 2.1 Modules**

Module	Description
PHID	User switch operation on the RSK board is converted into HID reports. The transfer result is notified to APL by the callback function. In addition, communicate the output report of HID host to APL.
USB-BASIC-FW	USB Basic Mini Host and Peripheral Driver

### 3. API Information

This Driver API follows the Renesas API naming standards.

#### 3.1 Hardware Requirements

This driver requires your MCU support the following features:

- USB

#### 3.2 Software Requirements

This driver is dependent upon the following packages:

- r\_bsp
- r\_usb\_basic\_mini

#### 3.3 Operating Confirmation Environment

Table 3-1 shows the operating confirmation environment of this driver.

Table 3-1 Operation Confirmation Environment

Item	Contents
C compiler	Renesas Electronics C/C++ compiler for RX Family V.3.02.00 (The option "-lang=C99" is added to the default setting of IDE) GCC for Renesas RX 8.3.0.201904 (The option "-std=gnu99" is added to the default setting of IDE) IAR C/C++ Compiler for Renesas RX version 4.14.1
Real-Time OS	FreeRTOS V.10.0.0 RI600V4 V.1.06
Endian	Little Endian, Big Endian
USB Driver Revision Number	Rev.1.20
Using Board	Renesas Starter Kit for RX111 Renesas Starter Kit for RX113 Renesas Starter Kit for RX231 Renesas Solution Starter Kit for RX231
Host Environment	The operation of this USB Driver module connected to the following OSes has been confirmed. <ol style="list-style-type: none"> <li>1. Windows® 8.1</li> <li>2. Windows® 10</li> </ol>

### 3.4 Usage of Interrupt Vector

Table 3-2 shows the interrupt vector which this driver uses.

Table 3-2 List of Usage Interrupt Vectors

Device	Contents
RX111	USBIO Interrupt (Vector number: 36) / USBR0 Interrupt (Vector number: 90) USB D0FIFO0 Interrupt (Vector number: 36) / USB D1FIFO0 Interrupt (Vector number: 37)
RX113	
RX231	
RX23W	

### 3.5 Header Files

All API calls and their supporting interface definitions are located in *r\_usb\_basic\_mini\_if.h* and *r\_usb\_phid\_mini\_if.h*.

### 3.6 Integer Types

This project uses ANSI C99 “Exact width integer types” in order to make the code clearer and more portable. These types are defined in *stdint.h*.

### 3.7 Compile Setting

For compile settings, refer to chapter 6, **Configuration (r\_usb\_phid\_mini\_config.h)** in this document and chapter "Configuration" in the document (Document number: R01AN2166) for *USB Basic Mini Host and Peripheral Driver (USB Mini Firmware) using Firmware Integration Technology Application Note*.

### 3.8 ROM / RAM Size

The follows show ROM/RAM size of this driver.

#### 1. CC-RX (Optimization Level: Default)

##### (1). Non-OS

	Checks arguments	Does not check arguments
ROM size	17.5K bytes (Note 3)	17.2K bytes (Note 4)
RAM size	3.3K bytes	3.3K bytes

##### (2). RI600V4

	Checks arguments	Does not check arguments
ROM size	34.1K bytes (Note 3)	33.8K bytes (Note 4)
RAM size	4.4K bytes	4.4K bytes

##### (3). FreeRTOS

	Checks arguments	Does not check arguments
ROM size	30.0K bytes (Note 3)	29.7K bytes (Note 4)
RAM size	14.7K bytes	14.7K bytes

#### 2. GCC (Optimization Level: -O2)

	Checks arguments	Does not check arguments
ROM size	19.0K bytes (Note 3)	18.7K bytes (Note 4)
RAM size	3.2K bytes	3.2K bytes

#### 3. IAR (Optimization Level: Medium)

	Checks arguments	Does not check arguments
ROM size	11.6K bytes (Note 3)	11.4K bytes (Note 4)
RAM size	2.6K bytes	2.6K bytes

## [Note]

1. ROM/RAM size for BSP and USB Basic Driver is included in the above size.
2. The above is the size when specifying RX V2 core option.
3. The ROM size of “Checks arguments” is the value when `USB_CFG_ENABLE` is specified to `USB_CFG_PARAM_CHECKING` definition in `r_usb_basic_mini_config.h` file.
4. The ROM size of “Does not check arguments” is the value when `USB_CFG_DISABLE` is specified to `USB_CFG_PARAM_CHECKING` definition in `r_usb_basic_mini_config.h` file.

### 3.9 Argument

For the structure used in the argument of API function, refer to chapter "Structures" in the document (Document number: R01AN2166) for *USB Basic Mini Host and Peripheral Driver (USB Mini Firmware) using Firmware Integration Technology Application Note*.

### 3.10 Adding the FIT Module to Your Project

This module must be added to each project in which it is used. Renesas recommends the method using the Smart Configurator described in (1) or (3) below. However, the Smart Configurator only supports some RX devices. Please use the methods of (2) or (4) for RX devices that are not supported by the Smart Configurator.

- (1) Adding the FIT module to your project using “Smart Configurator” on e<sup>2</sup> studio  
By using the Smart Configurator in e<sup>2</sup> studio, the FIT module is automatically added to your project. Refer to “Renesas e<sup>2</sup> studio Smart Configurator User Guide (R20AN0451)” for details.
- (2) Adding the FIT module to your project using the FIT Configurator in e<sup>2</sup> studio  
By using the FIT Configurator in e<sup>2</sup> studio, the FIT module is automatically added to your project. Refer to “Adding Firmware Integration Technology Modules to Projects (R01AN1723)” for details.
- (3) Adding the FIT module to your project using the Smart Configurator in CS+  
By using the Smart Configurator Standalone version in CS+, the FIT module is automatically added to your project. Refer to “Renesas e<sup>2</sup> studio Smart Configurator User Guide (R20AN0451)” for details.
- (4) Adding the FIT module to your project on CS+  
In CS+, please manually add the FIT module to your project. Refer to “Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)” for details.

## 4. USB Peripheral Human Interface Devices Class Driver (PHID)

### 4.1 Class Requests (Host to Peripheral)

This driver notifies to the application program when receiving the following class request.

For the class request processing, refer to chapter "USB Class Requests" in the document (Document number: R01AN2166) for *USB Basic Mini Host and Peripheral Driver (USB Mini Firmware) using Firmware Integration Technology Application Note*.

**Table 4.1 HID class requests**

Request	Code	Description
Get_Report	0x01	Receives a report from the HID host
Set_Report	0x09	Sends a report to the HID host
Get_Idle	0x02	Receives a duration (time) from the HID host
Set_Idle	0x0A	Sends a duration (time) to the HID host
Get_Protocol	0x03	Reads a protocol from the HID host
Set_Protocol	0x0B	Sends a protocol to the HID host
Get_Descriptor Descriptor Type : Class Class Descriptor Type : Report	0x06 (Standard)	Transmits a report descriptor
Get_Descriptor Descriptor Type : Class Class Descriptor Type : HID	0x06 (Standard)	Transmits an HID descriptor



## 4.2 Class Request Data Format

### 1. GetReport

**Table 4-1 GetReport Format**

bmRequestType	bRequest	wValue	wIndex	wLength	Data
0xA1	GET_REPORT (0x01)	ReportType & ReportID	Interface	ReportLength	Report

### 2. SetReport

**Table 4-2 SetReport Format**

bmRequestType	bRequest	wValue	wIndex	wLength	Data
0x21	SET_REPORT (0x09)	ReportType & ReportID	Interface	ReportLength	Report

### 3. GetIdle

**Table 4-3 GetIdle Format**

bmRequestType	bRequest	wValue	wIndex	wLength	Data
0xA1	GET_IDLE (0x02)	0(Zero) & ReportID	Interface	1(one)	Idle rate

### 4. SetIdle

**Table 4-4 SetIdle Format**

bmRequestType	bRequest	wValue	wIndex	wLength	Data
0x21	SET_IDLE (0x0A)	Duration & ReportID	Interface	0(zero)	Not applicable

### 5. GetProtocol

**Table 4-5 GetProtocol Format**

bmRequestType	bRequest	wValue	wIndex	wLength	Data
0xA1	GET_PROTOCOL (0x03)	0(zero)	Interface	0(zero)	0 (Boot Protocol) / 1 (Report Protocol)

### 6. SetProtocol

**Table 4-6 SetProtocol Format**

bmRequestType	bRequest	wValue	wIndex	wLength	Data
0x21	SET_PROTOCOL (0x0B)	0 (Boot Protocol) / 1 (Report Protocol)	Interface	0(zero)	Not applicable

## 5. API Functions

For API used in the application program, refer to chapter "**API Functions**" in the document (Document number: R01AN2166) for *USB Basic Mini Host and Peripheral Driver (USB Mini Firmware) using Firmware Integration Technology Application Note*.

## 6. Configuration (r\_usb\_phid\_mini\_config.h)

Please set the following according to your system.

Note:

Be sure to set *r\_usb\_basic\_mini\_config.h* file as well. For *r\_usb\_basic\_mini\_config.h* file, refer to chapter "**Configuration**" in the document (Document number: R01AN2166) for *USB Basic Mini Host and Peripheral Driver (USB Mini Firmware) using Firmware Integration Technology Application Note*.

### 1. Setting pipe to be used

Set the pipe number (PIPE6 to PIPE9) to use for Interrupt IN/OUT transfer. Do not set the same pipe number for the definitions of `USB_CFG_PHID_INT_IN` and `USB_CFG_PHID_INT_OUT`.

```
#define    USB_CFG_PHID_INT_IN           Pipe number (USB_PIPE6 to USB_PIPE9)
```

```
#define    USB_CFG_PHID_INT_OUT        Pipe number (USB_PIPE6 to USB_PIPE9)
```

Note:

For a system that does not support the OUT transfer, set `USB_NULL` as the definition of `USB_CFG_PHID_INT_OUT`.

## 7. Creating an Application

Refer to the chapter “**Creating an Application Program**” in the document (Document number: R01AN2166) for *USB Basic Mini Host and Peripheral Driver (USB Mini Firmware) using Firmware Integration Technology Application Note*.

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## Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Dec 1, 2014	—	First edition issued
1.01	Jun 1, 2015	—	RX231 is added in the target device.
1.02	Dec 28, 2015	—	1. API (R_usb_phid_receive_data) for OUT transfer is added. 2. Checked the operation with Windows® 10.
1.10	Nov 30, 2018	—	1. Supporting Smart Configurator. 2. The following chapter is added. (1). 5. API Functions 3. The following chapters are changed. (1). 3. API Information (2). 6. Configuration (r_usb_phid_mini_config.h) (3). 7. Creating an Application 4. The following chapters are deleted. "How to Register Class Driver", "System Resources", "Task ID and Priority Setting", "USB Peripheral Communication Device Class Driver".
1.11	May 31, 2019	—	Support GCC compiler and IAR compiler.
1.12	Jun 30, 2019	—	RX23W is added in the target device.
1.20	Jun 1, 2020	—	Support the real time OS.

## General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

### 1. Handling of Unused Pins

Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

### 2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.  
In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.  
In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

### 3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

### 4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

### 5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

- The characteristics of Microprocessing unit or Microcontroller unit products in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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Renesas Electronics Corporation

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#### Renesas Electronics Corporation

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan

#### Renesas Electronics America Inc. Milpitas Campus

1001 Murphy Ranch Road, Milpitas, CA 95035, U.S.A.

Tel: +1-408-432-8888, Fax: +1-408-434-5351

#### Renesas Electronics America Inc. San Jose Campus

6024 Silver Creek Valley Road, San Jose, CA 95138, USA

Tel: +1-408-284-8200, Fax: +1-408-284-2775

#### Renesas Electronics Canada Limited

9251 Yonge Street, Suite 8309 Richmond Hill, Ontario Canada L4C 9T3

Tel: +1-905-237-2004

#### Renesas Electronics Europe GmbH

Arcadiastrasse 10, 40472 Düsseldorf, Germany

Tel: +49-211-6503-0, Fax: +49-211-6503-1327

#### Renesas Electronics (China) Co., Ltd.

Room 101-T01, Floor 1, Building 7, Yard No. 7, 8th Street, Shangdi, Haidian District, Beijing 100085, China

Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

#### Renesas Electronics (Shanghai) Co., Ltd.

Unit 301, Tower A, Central Towers, 555 Langao Road, Putuo District, Shanghai 200333, China

Tel: +86-21-2226-0888, Fax: +86-21-2226-0999

#### Renesas Electronics Hong Kong Limited

Unit 1601-1611, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong

Tel: +852-2265-6688, Fax: +852-2886-9022

#### Renesas Electronics Taiwan Co., Ltd.

13F, No. 363, Fu Shing North Road, Taipei 10543, Taiwan

Tel: +886-2-8175-9600, Fax: +886-2-8175-9670

#### Renesas Electronics Singapore Pte. Ltd.

80 Bendemeer Road, #06-02 Singapore 339949

Tel: +65-6213-0200, Fax: +65-6213-0300

#### Renesas Electronics Malaysia Sdn.Bhd.

Unit No 3A-1 Level 3A Tower 8 UOA Business Park, No 1 Jalan Pengerutarcua U1/51A, Seksyen U1, 40150 Shah Alam, Selangor, Malaysia

Tel: +60-3-5022-1288, Fax: +60-3-5022-1290

#### Renesas Electronics India Pvt. Ltd.

No.777C, 100 Feet Road, HAL 2nd Stage, Indiranagar, Bangalore 560 038, India

Tel: +91-80-67208700

#### Renesas Electronics Korea Co., Ltd.

17F, KAMCO Yangjae Tower, 262, Gangnam-daero, Gangnam-gu, Seoul, 06265 Korea

Tel: +82-2-558-3737, Fax: +82-2-558-5338